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October 2013

## RURG3060CC\_F085 30A, 600V Ultrafast Rectifier

#### **Features**

- High Speed Switching (t<sub>rr</sub>=60ns(Typ.) @ I<sub>F</sub>=30A)
- Low Forward Voltage( V<sub>F</sub>=1.5V(Max.) @ I<sub>F</sub>=30A )
- · Avalanche Energy Rated
- · AEC-Q101 Qualified

## **Applications**

- · Automotive DCDC converter
- · Automotive On Board Charger
- · Switching Power Supply
- · Power Switching Circuits

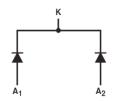
#### 30A, 600V Ultrafast Rectifier

The RURG3060\_F085 is an dual ultrafast diode with soft recovery characteristics (trr<80ns). It has low forward voltage drop and is silicon nitride passivated ionimplanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and ultrafast recovery with soft recovery characteristic minimizes ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

## **Pin Assignments**





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
$V_{RRM}$	Peak Repetitive Reverse Voltage	600	V	
$V_{RWM}$	Working Peak Reverse Voltage	600	V	
V <sub>R</sub>	DC Blocking Voltage	600	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 25°C	30	Α	
I <sub>FSM</sub>	Non-repetitive Peak Surge Current (Halfwave 1 Phase 50Hz)	90	А	
E <sub>AVL</sub>	Avalanche Energy (1A, 40mH)	20	mJ	
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 55 to +175	°C	

#### Thermal Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Max	Units	
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case (Single Anode)	1	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient 45		°C/W	

## **Package Marking and Ordering Information**

<b>Device Marking</b>	Device	Package	Tube	Quantity	
RURG3060CC	RG3060CC RURG3060CC_F085 TO-247		•	30	

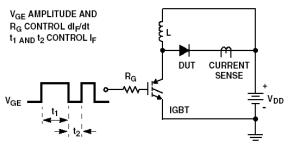
## Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted, for Single anode

Symbol	Parameter	Conditions		Min.	Тур.	Max	Units
I <sub>R</sub>	Instantaneous Reverse Current	V <sub>R</sub> = 600V	T <sub>C</sub> = 25 °C	-	-	250	uA
			T <sub>C</sub> = 175 °C	-	-	1	mA
V <sub>FM</sub> <sup>1</sup>	Instantaneous Forward Voltage	I <sub>F</sub> = 30A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 175 °C	-	1.26 1.06	1.5 1.3	V
t <sub>rr</sub> <sup>2</sup>	Reverse Recovery Time	$I_F$ =1A, di/dt = 100A/ $\mu$ s, $V_{CC}$ = 390V	T <sub>C</sub> = 25 °C	-	35	55	ns
		$I_F$ =30A, di/dt = 100A/ $\mu$ s, $V_{CC}$ = 390V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 175 °C	-	60 231	80	ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	Reverse Recovery Time Reverse Recovery Charge	$I_F = 30A$ , di/dt = 100A/ $\mu$ s, $V_{CC} = 390V$	T <sub>C</sub> = 25 °C	- - -	31 29 92	- - -	ns ns nC
E <sub>AVL</sub>	Avalanche Energy	I <sub>AV</sub> =1.0A,L = 40mH	•	20	-	-	mJ

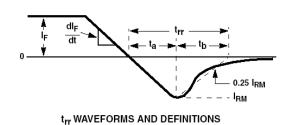
#### Notes

- 1. Test Pulse Width = 300us, Duty Cycle = 3%
- 2 Guaranteed by design.

#### **Test Circuit and Waveforms**



trr TEST CIRCUIT



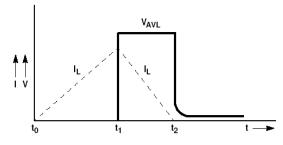
I<sub>MAX</sub> = 1A L = 40mH R < 0.1Ω E<sub>AVL</sub> = 1/2LI<sup>2</sup> [V<sub>R(AVL)</sub>/(V<sub>R(AVL)</sub> - V<sub>DD</sub>)] Q<sub>1</sub> = IGBT (BV<sub>CES</sub> > DUT V<sub>R(AVL)</sub>) CURRENT SENSE

V<sub>DD</sub>

V<sub>DD</sub>

V<sub>DD</sub>

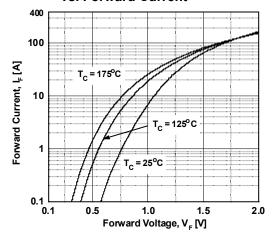
**AVALANCHE ENERGY TEST CIRCUIT** 



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

## Typical Performance Characteristics Single Anode

Figure 1. Typical Forward Voltage Drop vs. Forward Current



**Figure 3.Typical Junction Capacitance** 

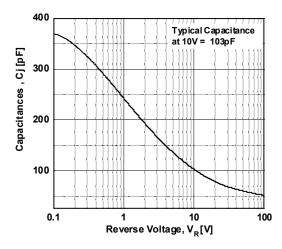


Figure 5. Typical Reverse Recovery Current vs. di/dt

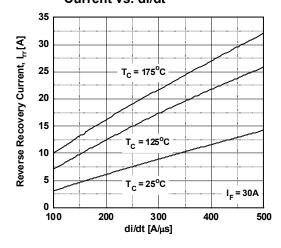


Figure 2. Typical Reverse Current vs.

Reverse Voltage

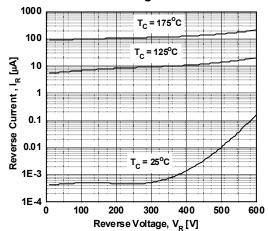
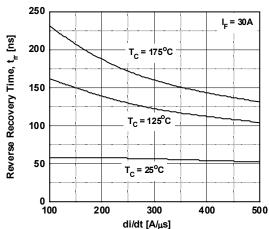
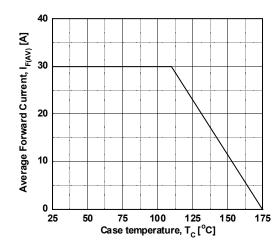


Figure 4. Typical Reverse Recovery Time vs. di/dt



**Figure 6. Forward Current Derating Curve** 



## **Typical Performance Characteristics** (Continued)

Figure 7. Reverse Recovery Charge

2500

I<sub>F</sub> = 30A

T<sub>C</sub> = 175°C

T<sub>C</sub> = 125°C

T<sub>C</sub> = 25°C

1000

200

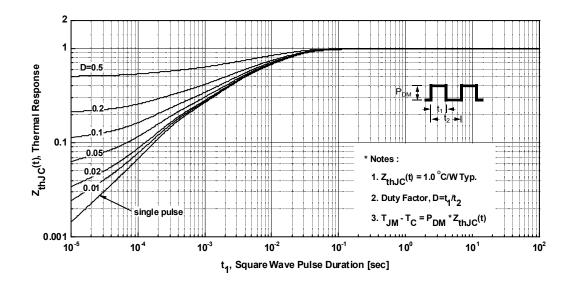
300

400

500

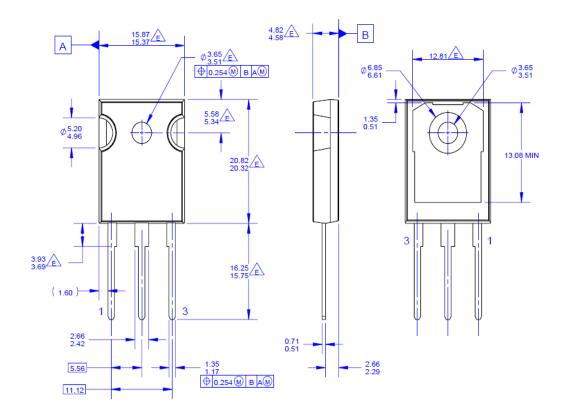
Figure 8. Transient Thermal Response Curve

di/dt [A/μs]



## **Mechanical Dimensions**

TO-247-3L



Dimensions in Millimeters





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